



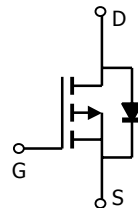
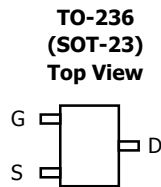
**AO3403, AO3403L (Lead-Free)
P-Channel Enhancement Mode Field Effect Transistor**

General Description

The AO3403 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. AO3403L is offered in a lead free package.

Features

- V_{DS} (V) = -30V
- I_D = -2.6 A
- $R_{DS(ON)} < 130m\Omega$ ($V_{GS} = -10V$)
- $R_{DS(ON)} < 180m\Omega$ ($V_{GS} = -4.5V$)
- $R_{DS(ON)} < 260m\Omega$ ($V_{GS} = -2.5V$)



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^A	$T_A=25^\circ\text{C}$	-2.6	A
	$T_A=70^\circ\text{C}$	-2.2	
Pulsed Drain Current ^B	I_{DM}	-20	
Power Dissipation ^A	$T_A=25^\circ\text{C}$	1.4	W
	$T_A=70^\circ\text{C}$	1	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	70	90	$^\circ\text{C/W}$
Maximum Junction-to-Ambient ^A		Steady-State	100	
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	63	80	$^\circ\text{C/W}$

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.6	-1	-1.4	V
$I_{D(ON)}$	On state drain current	$V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$	-10			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}, I_D=-2.6\text{A}$ $T_J=125^\circ\text{C}$		102 154	130 200	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}, I_D=-2\text{A}$		128	180	$\text{m}\Omega$
		$V_{GS}=-2.5\text{V}, I_D=-1\text{A}$		187	260	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-2.5\text{A}$	3	4.5		S
V_{SD}	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.85	-1	V
I_S	Maximum Body-Diode Continuous Current				-2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance			409		pF
C_{oss}	Output Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		55		pF
C_{riss}	Reverse Transfer Capacitance			42		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		12		Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge			4.4		nC
Q_{gs}	Gate Source Charge	$V_{GS}=-4.5\text{V}, V_{DS}=-15\text{V}, I_D=-2.5\text{A}$		0.8		nC
Q_{gd}	Gate Drain Charge			1.32		nC
$t_{D(on)}$	Turn-On DelayTime			5.3		ns
t_r	Turn-On Rise Time	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=6\Omega,$ $R_{GEN}=3\Omega$		4.4		ns
$t_{D(off)}$	Turn-Off DelayTime			31.5		ns
t_f	Turn-Off Fall Time			8		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-2.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		15.8		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-2.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		8		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any a given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

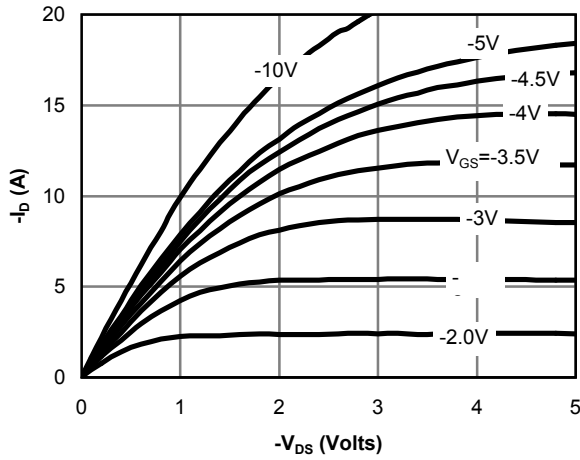


Fig 1: On-Region Characteristics

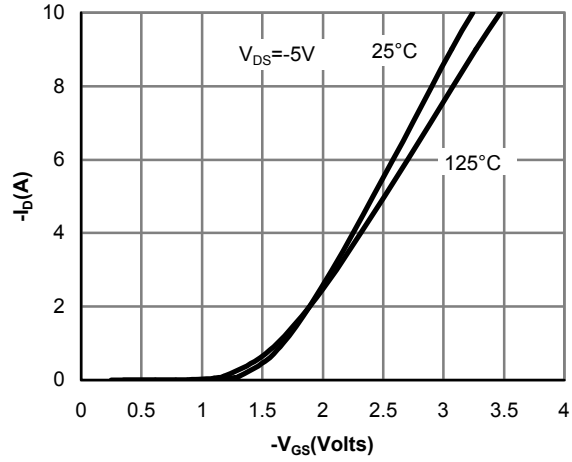


Figure 2: Transfer Characteristics

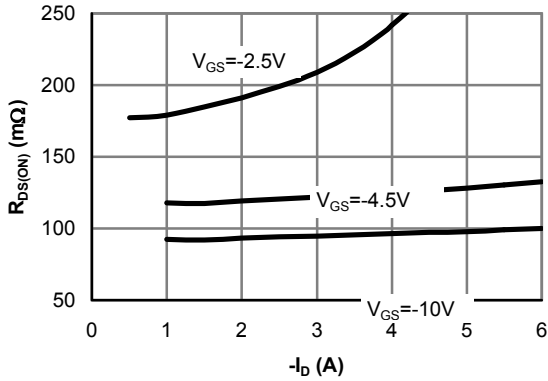


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

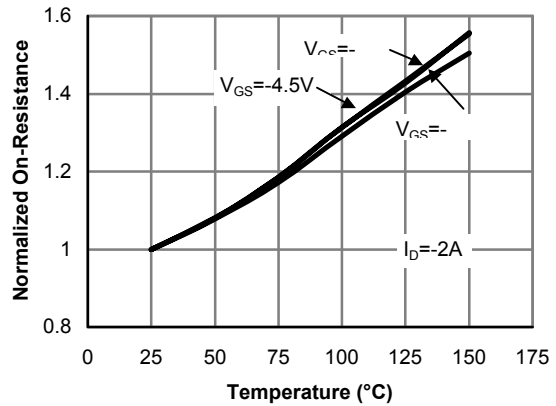


Figure 4: On-Resistance vs. Junction Temperature

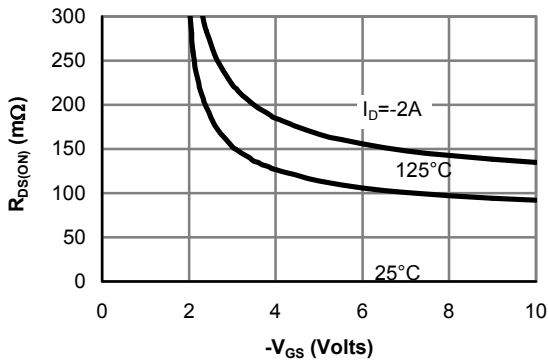


Figure 5: On-Resistance vs. Gate-Source Voltage

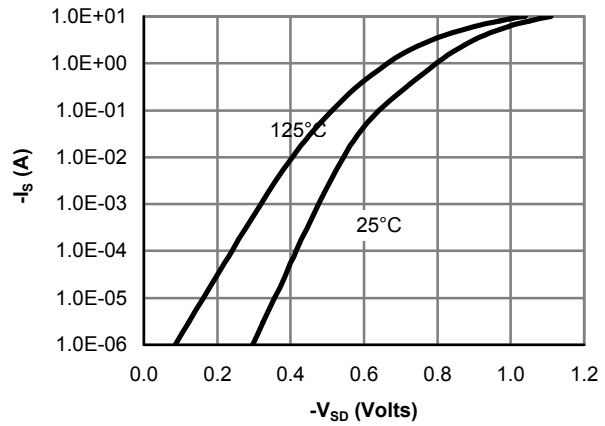


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

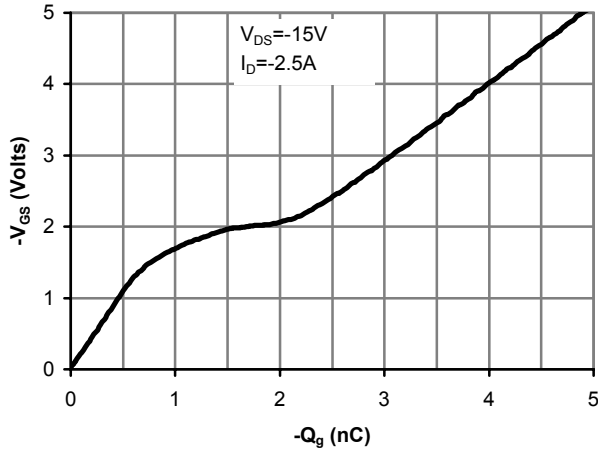


Figure 7: Gate-Charge Characteristics

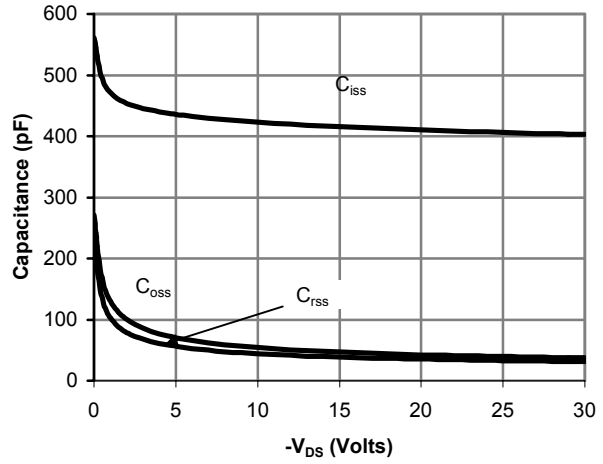


Figure 8: Capacitance Characteristics

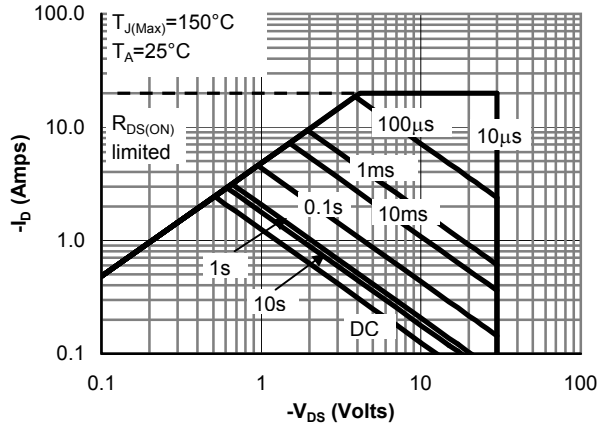


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

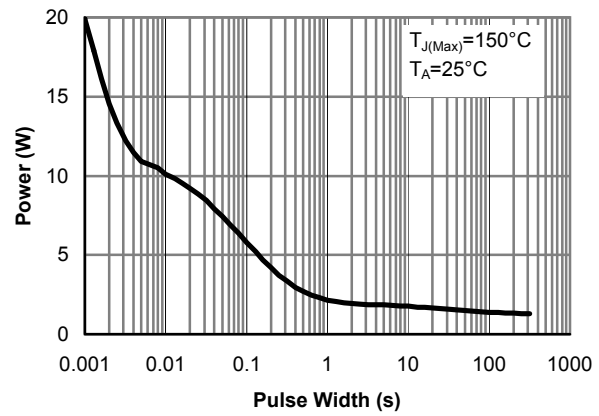


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

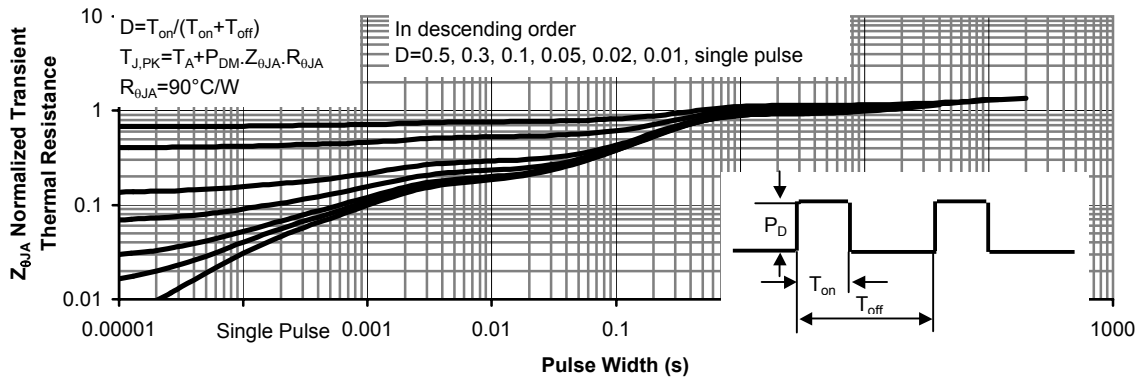
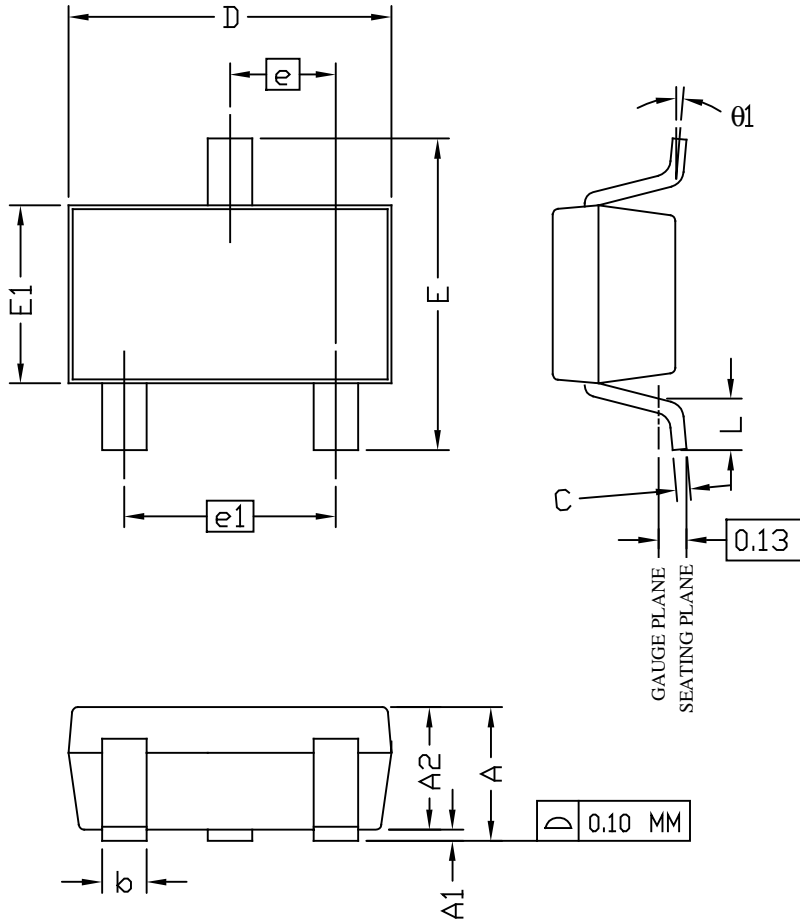


Figure 11: Normalized Maximum Transient Thermal Impedance



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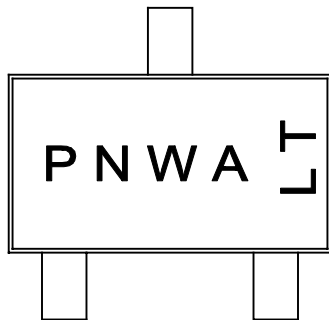
Document No.	PD-00004
Version	rev B
Title	AO3403 Package Data Sheet



SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	1.00	—	1.25
A1	0.00	—	0.10
A2	1.00	1.10	1.15
b	0.35	0.40	0.50
C	0.10	0.15	0.25
D	2.80	2.90	3.04
E	2.60	2.80	2.95
E1	1.40	1.60	1.80
e	—	0.95 BSC	—
e1	—	1.90 BSC	—
L	0.40	—	0.60
$\theta 1$	1°	5°	8°

- NOTE:
- LEAD FINISH: 150 MICRONS (3.8 μ m) MIN. THICKNESS OF Tin/Lead (SOLDER) PLATED ON LEAD
 - TOLERANCE ± 0.10 mm (4 mil) UNLESS OTHERWISE SPECIFIED
 - COPLANARITY : 0.10 mm
 - DIMENSION L IS MEASURED IN GAGE PLANE

PACKAGE MARKING DESCRIPTION

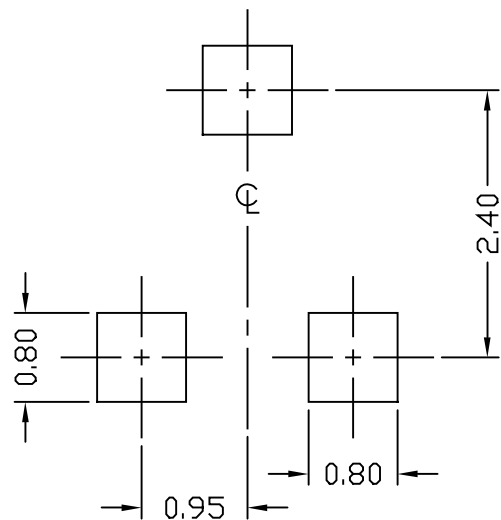


SOT-23 PART NO. CODE

PART NO.	CODE
AO3403	A3

- NOTE:
- P - Package and product type.
 - N - Last digital of product number.
 - W - Week code
 - A - Foundry location code
 - LT - Assembly lot code.

RECOMMENDATION OF LAND PATTERN

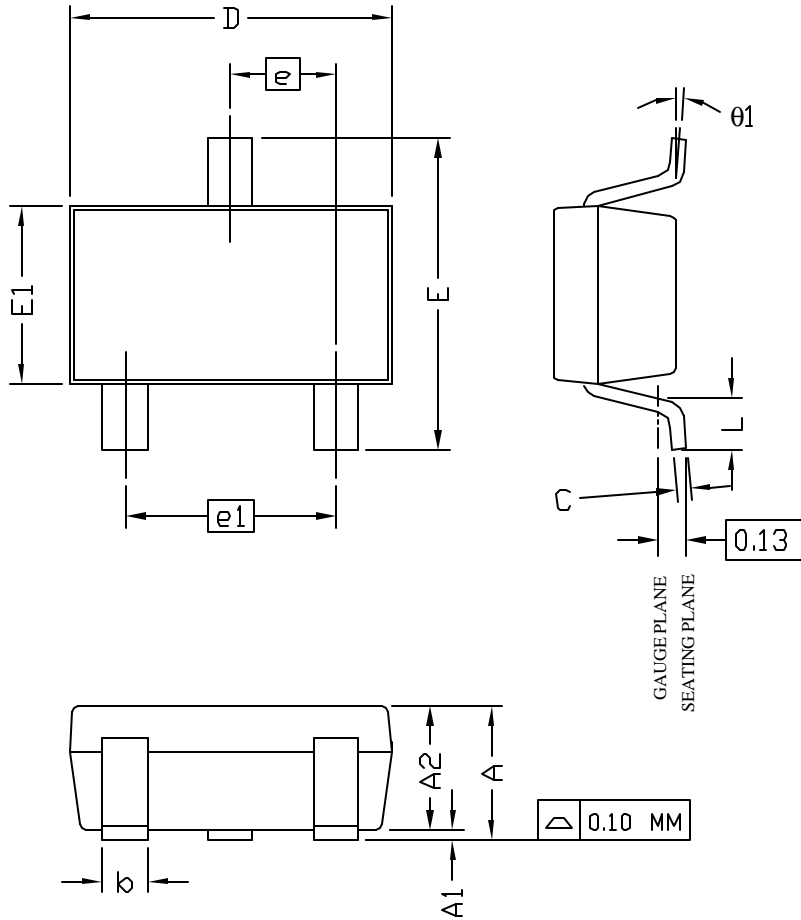




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Document No.	PD-00095
Version	rev B
Title	AO3403L Package Data Sheet

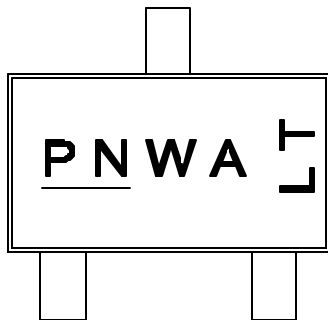
SOT-23 LEAD FREE



SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	1.00	—	1.25
A1	0.00	—	0.10
A2	1.00	1.10	1.15
b	0.35	0.40	0.50
C	0.10	0.15	0.25
D	2.80	2.90	3.04
E	2.60	2.80	2.95
E1	1.40	1.60	1.80
e	—	0.95 BSC	—
e1	—	1.90 BSC	—
L	0.40	—	0.60
$\theta 1$	1°	5°	8°

- NOTE:
- LEAD FINISH: LEAD FREE COATING
 - TOLERANCE ± 0.10 mm (4 mil) UNLESS OTHERWISE SPECIFIED
 - COPLANARITY : 0.10 mm
 - DIMENSION L IS MEASURED IN GAGE PLANE

PACKAGE MARKING DESCRIPTION

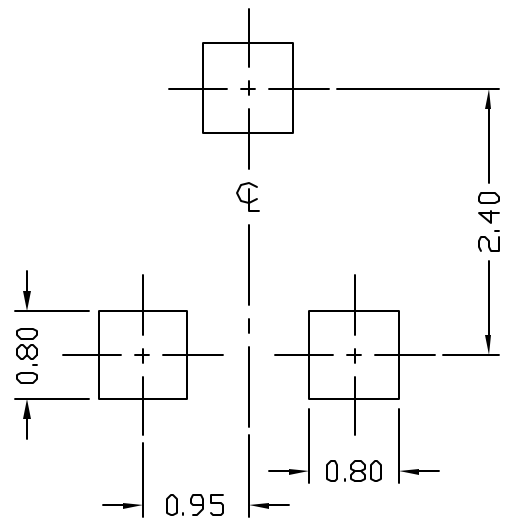


SOT-23 PART NO. CODE

PART NO.	CODE
AO3403L	A3

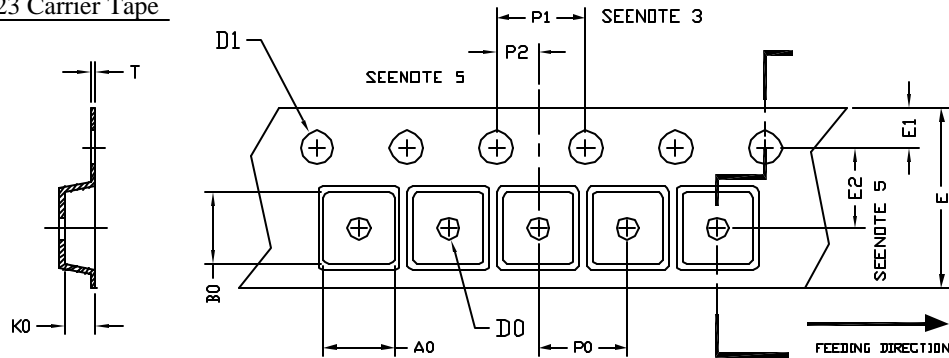
- NOTE:
- P - Package and product type, Lead_Free.
 - N - Last digital of product number.
 - W - Week code
 - A - Foundry location code
 - LT - Assembly lot code.

RECOMMENDATION OF LAND PATTERN





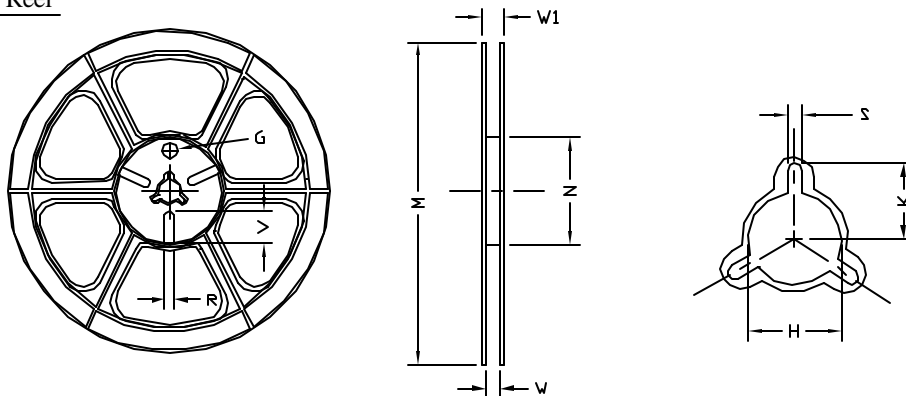
SOT-23 Carrier Tape



UNIT: MM

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOT-23 (8 mm)	3.15 ±0.10	3.20 ±0.10	1.40 ±0.10	1.00 MIN	1.30 +0.10	8.00 ±0.30	1.75 ±0.10	3.50 ±0.05	4.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.25 ±0.05

SOT-23 Reel



UNIT: MM

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
8 mm	φ180	φ180.00 ±0.50	φ60.50	9.00 ±0.30	11.40 ±1.00	φ13.00 +0.50 -0.20	10.60	2.00 ±0.50	φ9.00	5.00	18.00

SOT-23 Tape

Leader / Trailer
& Orientation

